

SPN4436S8RGB-VB Datasheet

N-Channel 60-V (D-S) MOSFET

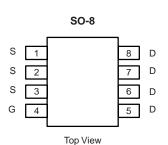
PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^d	Q _g (Typ.)			
60	0.025 at V _{GS} = 10 V	7.6	10.5 nC			
00	0.035 at V _{GS} = 4.5 V	6.5	10.5 HC			

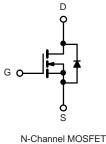
FEATURES

- Halogen-free According to IEC 61249-2-21
 Definition
- TrenchFET[®] Power MOSFET
- Optimized for "Low Side" Synchronous Rectifier Operation
- 100 % R_g and UIS Tested



CCFL Inverter





Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	60	V		
Gate-Source Voltage		V _{GS}	± 20	V	
	T _C = 25 °C		7.6 ^a		
Continuous Drain Current (T_{I} = 150 °C)	T _C = 70 °C		6.8		
$Continuous Drain Current (1) = 150^{\circ} C)$	T _A = 25 °C	I _D	6.1 ^{b, c}		
	T _A = 70 °C		4.8 ^{b, c}		
Pulsed Drain Current	I _{DM}	25	— A		
	T _C = 25 °C	1	4.2		
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	2.1 ^{b, c}		
Avalanche Current		I _{AS}	15		
Single-Pulse Avalanche Energy	L = 0.1 mH	E _{AS}	11.2	mJ	
	T _C = 25 °C		5		
Maximum David Dissis atian	T _C = 70 °C		3.2	w	
Maximum Power Dissipation	T _A = 25 °C	P _D	2.5 ^{b, c}		
	T _A = 70 °C		1.6 ^{b, c}		
Operating Junction and Storage Temperature Range	T _J , T _{stq}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	38	50	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	20	25	C/VV	

Notes:

a. Package limited.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under Steady State conditions is 85 °C/W.



COMPLIANT HALOGEN FREE Available



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static	-					
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_{D} = 250 \mu A$	60			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	1 250 1		55		mV/°C
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA		- 6.3		
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	1.2		2.5	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
Zene Octo Malta na Davia Orana at	I _{DSS}	V _{DS} = 60 V, V _{GS} = 0 V			1	
Zero Gate Voltage Drain Current		V _{DS} = 60 V, V _{GS} = 0 V, T _J = 55 °C	1 1		10	μA
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	25			А
		V _{GS} = 10 V, I _D = 4.6 A	0.025			-
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_{D} = 4.2 \text{ A}$		0.035	0.035	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 4.6 A		20		S
Dynamic ^b	L				<u> </u>	
Input Capacitance	C _{iss}			1100		pF
Output Capacitance	C _{oss}	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$		90		
Reverse Transfer Capacitance	C _{rss}			55		
Total Gate Charge		$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 4.6 \text{ A}$		21	32	
	Qg			10.5	16	nC
Gate-Source Charge	Q _{gs}	$V_{DS} = 30$ V, $V_{GS} = 4.5$ V, $I_{D} = 4.6$ A		3.5		
Gate-Drain Charge	Q _{gd}			4.2		
Gate Resistance	R _g	f = 1 MHz		3.3	5	Ω
Turn-On Delay Time	t _{d(on)}			20	30	-
Rise Time	t _r	V_{DD} = 30 V, R_L = 5.4 Ω		150	225	
Turn-Off DelayTime	t _{d(off)}	$I_D \cong 5.6 \text{ A}, \text{ V}_{\text{GEN}}$ = 4.5 V, R_g = 1 Ω		20	30	
Fall Time	t _f			60	90	~~~
Turn-On Delay Time	t _{d(on)}			10	15	ns
Rise Time	t _r	V_{DD} = 30 V, R_L = 5.4 Ω		15	25	
Turn-Off DelayTime	t _{d(off)}	${\sf I}_{\sf D}\cong$ 5.6 A, ${\sf V}_{\sf GEN}$ = 10 V, ${\sf R}_{\sf g}$ = 1 Ω		25	40	
Fall Time	t _f			10	15	
Drain-Source Body Diode Characterist	ics					
Continous Source-Drain Diode Current	۱ _S	T _C = 25 °C			4.2	^
Pulse Diode Forward Current ^a	I _{SM}				25	A
Body Diode Voltage	V _{SD}	I _S = 2 A		0.8	1.2	V
Body Diode Reverse Recovery Time	t _{rr}	-		25	50	ns
Body Diode Reverse Recovery Charge		$\frac{Q_{rr}}{t_a}$ I _F = 5.5 A, dl/dt = 100 A/µs, T _J = 25 °C		25	50	nC
Reverse Recovery Fall Time				19		
Reverse Recovery Rise Time	t _b			6		ns

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



3.0

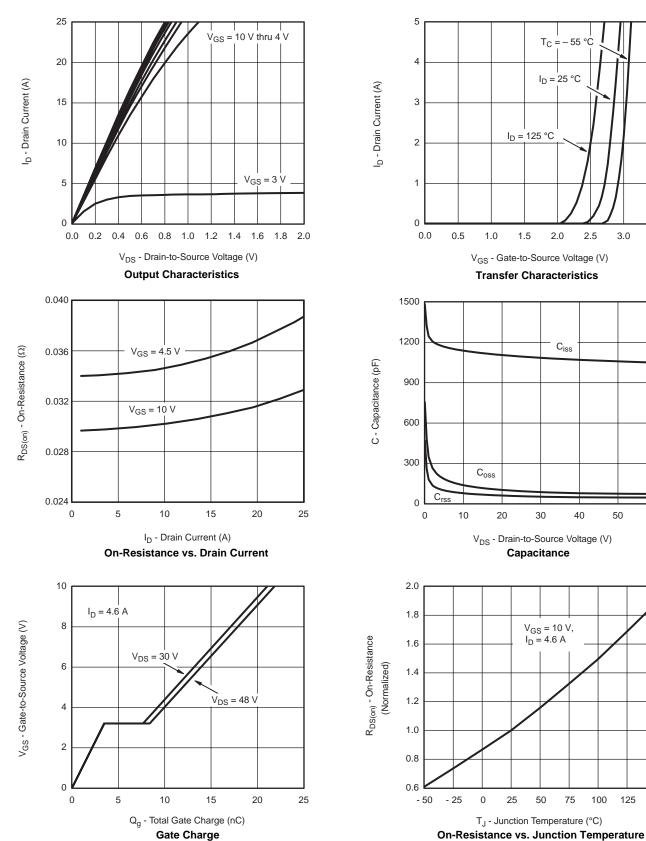
50

100

125

60

3.5

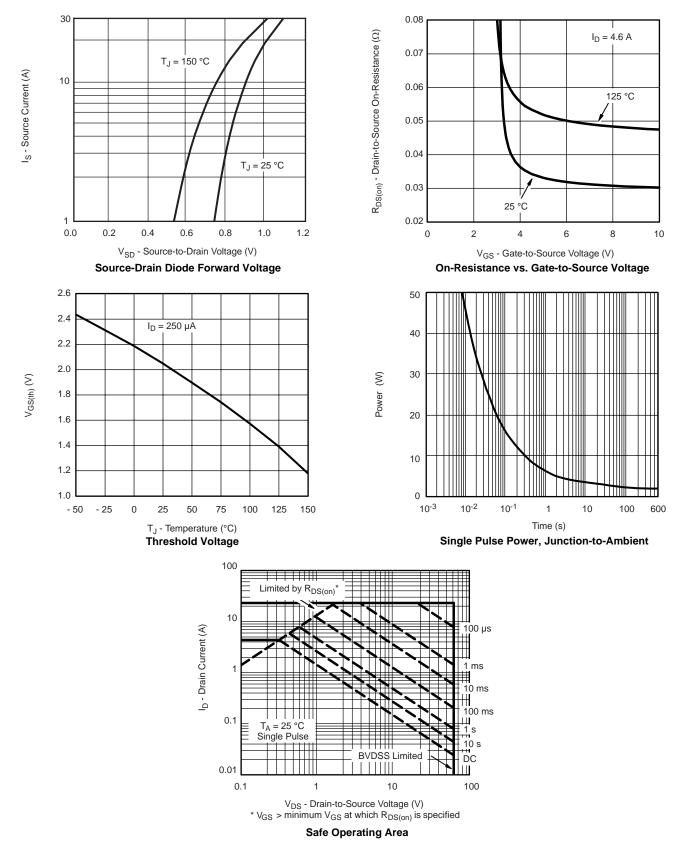


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

服务热线:400-655-8788

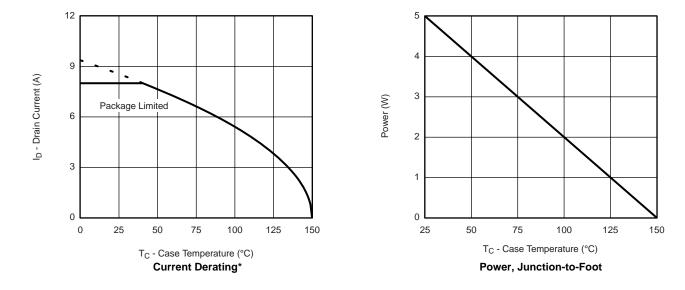
150





TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



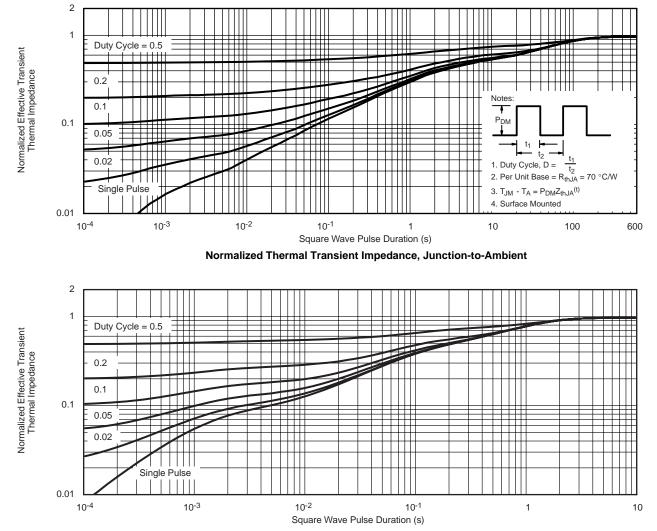


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





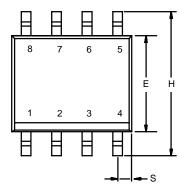


Normalized Thermal Transient Impedance, Junction-to-Foot



SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012

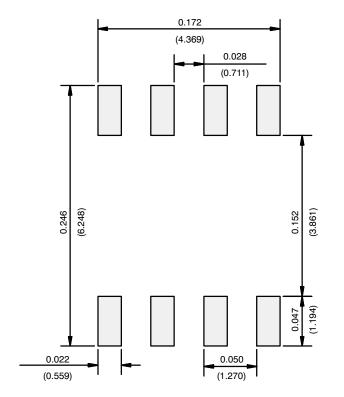




	MILLIMETERS		INC	HES		
DIM	Min	Max	Min	Max		
A	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
E	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050	0.050 BSC		
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498						



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)



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